RDN100N20

Transistors

Switching (200V, 10A)

RDN100N20

Features

- 1) Low on-resistance.
- 2) Low input capacitance.
- 3) Exellent resistance to damage from static electricity. WWW.DZS

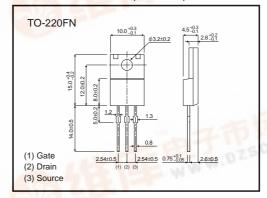
Application

Switching

Structure

Silicon N-channel MOS FET

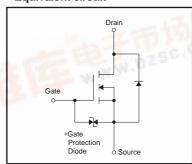
●External dimensions (Unit : mm)



Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-Source Voltage		V _{DSS}	200	V
Gate-Source Voltage		Vgss	±30	V
Drain Current	Continuous	ΙD	10	А
	Pulsed	IDP *1	40	А
Reverse Drain Current	Continuous	Idr	10	A
	Pulsed	IDRP *1	40	A
Avalanche Current		I _{AS} *2	10	A
Avalanche Energy		E _{AS} *2	120	mJ
Total Power Dissipation (Tc=25°C)		PD	35	W
Channel Temperature		T _{ch}	150	°C
Storage Temperature		T _{stg}	-55 to +150	°C

●Equivalent circuit



*A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection



^{*1} Pw ≤ 10μs, Duty cycle ≤ 1% *2 L≒ 4.5mH, Vpp=50V, Rg=25Ω, 1Pulse, Tch=25°C

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-Source Leakage	Igss	_	_	±10	μА	Vgs=±30V, Vgs=0V
Drain-Source Breakdown Voltage	V(BR) DSS	200	_	_	V	I _D =250μA, V _G s=0V
Zero Gate Voltage Drain Current	IDSS	_	_	25	μА	Vps=200V, Vgs=0V
Gate Threshold Voltage	VGS (th)	2.0	_	4.0	V	VDS=10V, ID=1mA
Static Drain-Source On-State Resistance	RDS (on)	_	0.27	0.36	Ω	In=5A, Vgs=10V
Forward Transfer Admittance	Yfs	2.3	3.8	_	S	VDS=10V, ID=5A
Input Capacitance	Ciss		543	_	pF	Vps=10V
Output Capacitance	Coss	_	193	_	pF	V _{GS} =0V
Reverse Transfer Capacitance	Crss		64	_	pF	f=1MHz
Turn-On Delay Time	td (on)	_	13	_	ns	ID=5A, VDD ≒100V
Rise Time	tr	_	29	_	ns	Vgs=10V
Turn-Off Delay Time	td (off)	_	38	_	ns	RL=20Ω
Fall Time	t f	_	26	_	ns	Rgs=10Ω
Reverse Recovery Time	trr	_	133	_	ns	IDR=10A, VGS=0V
Reverse Recovery Charge	Qrr	_	0.54	_	μС	di / dt=100A / μs
Total Gate Charge	Qg	_	15	_	nC	VDD=100V,VGS=10V,ID=10A

•Electrical characteristic curves

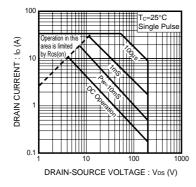


Fig.1 Maximun Safe Operating Area

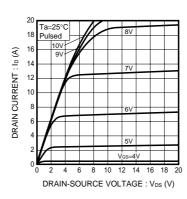


Fig.2 Typical Output Characteristics

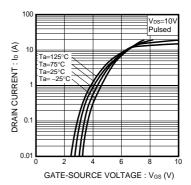


Fig.3 Typical Transfer Characteristics

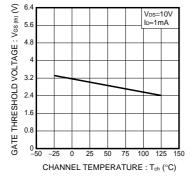


Fig.4 Gate Threshold Voltage vs. Channel Temperature

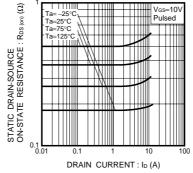


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

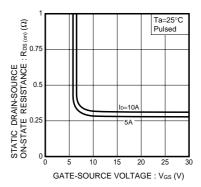


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

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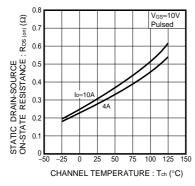


Fig.7 Static Drain-Source On-State Resistance vs. Channel Temperature

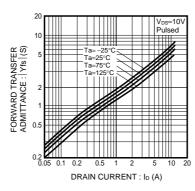


Fig.8 Forward Transfer Admittance vs. Drain Current

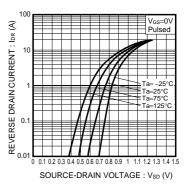


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

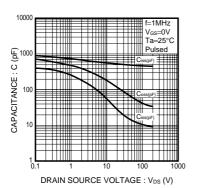


Fig.10 Typical Capacitance vs. Drain-Source Voltage

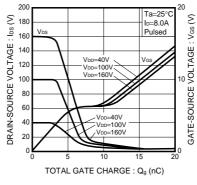


Fig.11 Dynamic Input Characteristics

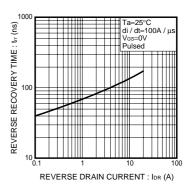


Fig.12 Reverse Recovery Time vs. Reverse Drain Current

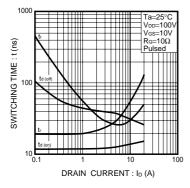


Fig.13 Switching Characteristcs

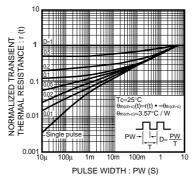


Fig.14 Normalized Transient Thermal Resistance vs. Pulse Width

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